

**REMARKS**

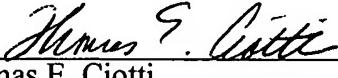
Attached hereto is a marked-up version of the changes made to the specification and claims by the current amendment. The attached page is captioned "Version with markings to show changes made".

In the unlikely event that the transmittal letter is separated from this document and the Patent Office determines that an extension and/or other relief is required, applicant petitions for any required relief including extensions of time and authorizes the Assistant Commissioner to charge the cost of such petitions and/or other fees due in connection with the filing of this document to Deposit Account No. 03-1952 referencing docket no. 259052002900.

Respectfully submitted,

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**VERSION WITH MARKINGS TO SHOW CHANGES MADE**

**In the Claims:**

4. (Amended) A light-emitting diode claimed in Claim 1[or 2], wherein the light reflecting layer is formed of a metal thin film.

6. (Amended) A light-emitting diode claimed in Claim 4 [or 5], wherein the metal thin film is formed of an Ni vapor-deposition film.

8. (Amended) A light-emitting diode claimed in [any one of] Claim[s] 1[to 7], wherein the Ni vapor-deposition film has a thickness of 100 nm or more.

10. (Amended) A light-emitting diode claimed in Claim[s] 1[to 9], wherein the substrate is formed of a transparent substrate transparent to color emitted by the light-emitting diode chip.

Claims 12-27 have been added